



Power MOSFETS

DATASHEET

LM40017NAK8A

N-Channel
Enhancement Mode MOSFET

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Quality Management Systems
ISO 9001:2015 Certificate

N-Channel Enhancement Mode MOSFET

Pin Description

PDFN5*6 (TOP view)	Symbol	Symbol	N-Channel	Unit
		V_{DSS}	40	V
		$R_{DS(ON)-Max}$	1.7	$\text{m}\Omega$
		ID	188	A

Feature

- Very Low RDS(on) at 4.5V_{GS}
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Applications

- Power Load Switch
- Battery Powered System

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM40017NAK8A	PDFN5*6	Tape & Reel	5000 / Tape & Reel	40017 □□□□□G

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter		N-Channel	Unit
V_{DSS}	Drain-Source Voltage	$T_c=25^\circ\text{C}$	40	V
V_{GSS}	Gate-Source Voltage		± 20	
T_J	Maximum Junction Temperature		150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		-55 to 150	$^\circ\text{C}$
$I_{DM}^{\text{(1)}}$	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$	400	A
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	188	A
		$T_c=100^\circ\text{C}$	119	
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	96	W
		$T_c=100^\circ\text{C}$	39	
$I_{AS}^{\text{(2)}}$	Avalanche Current, Single pulse	$L=0.1\text{mH}$	65	A
$E_{AS}^{\text{(2)}}$	Avalanche Energy, Single pulse	$L=0.1\text{mH}$	211	mJ

Thermal Characteristics

Symbol	Parameter		Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	1.3	$^\circ\text{C/W}$
$R_{\theta JA}^{\text{(3)}}$	Thermal Resistance-Junction to Ambient	Steady State	50	$^\circ\text{C/W}$

Note ① : Max. current is limited by bonding wire

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150 °C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

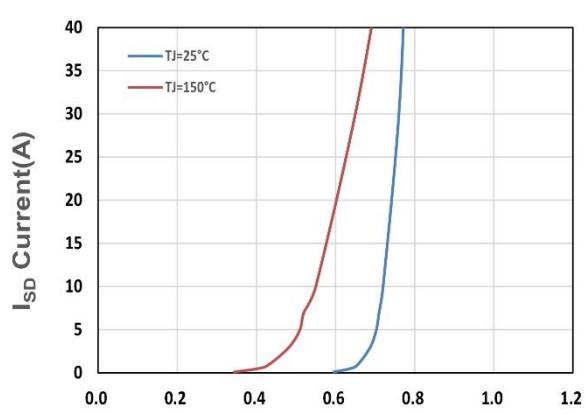
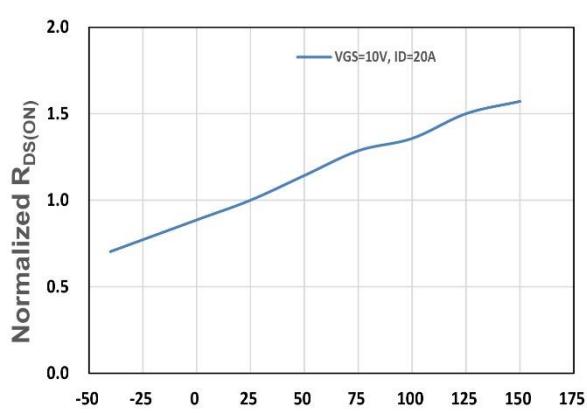
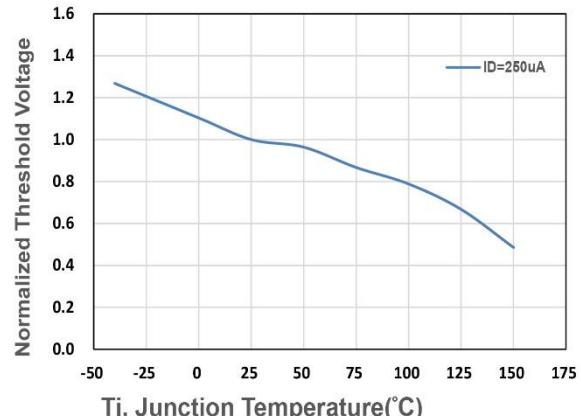
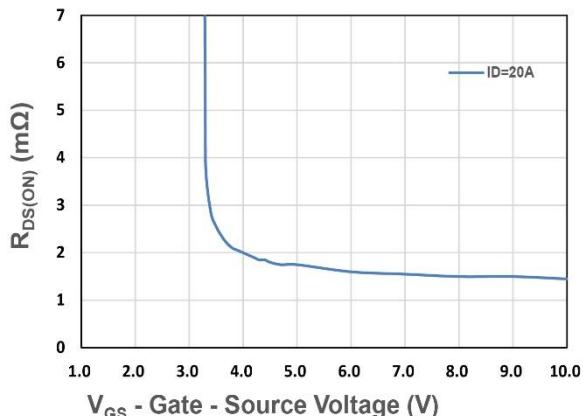
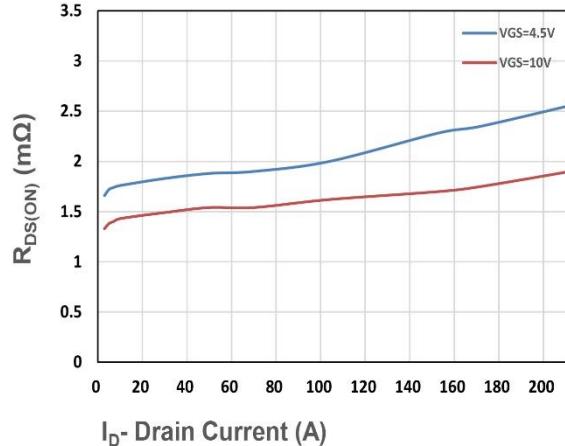
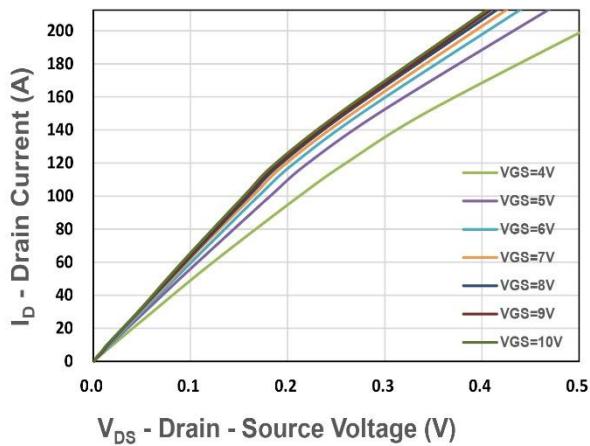
N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

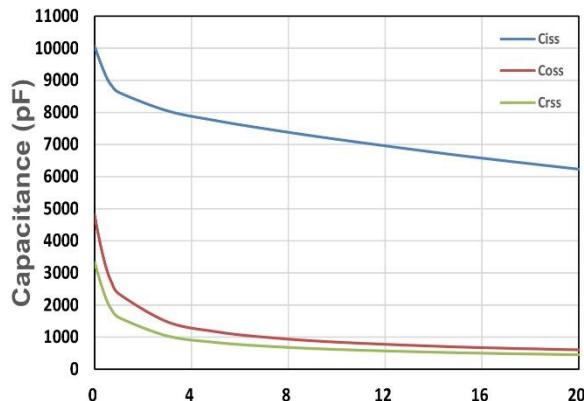
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
$\mathbf{BV_{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_{DS}=250\mu\text{A}$	40	-	-	V
$\mathbf{I_{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=36\text{V}$, $V_{GS}=0\text{V}$	-	-	1	μA
$\mathbf{V_{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{DS}=250\mu\text{A}$	1	1.5	2	V
$\mathbf{I_{GSS}}$	Gate Leakage Current	$V_{GS}=\pm 20\text{V}$, $V_{DS}=0\text{V}$	-	-	± 100	nA
$\mathbf{R_{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{GS}=10\text{V}$, $I_{DS}=20\text{A}$	-	1.45	1.7	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}$, $I_{DS}=15\text{A}$	-	1.8	2.3	
$\mathbf{g_{fs}}$	Forward Transconductance	$V_{DS}=5\text{V}$, $I_{DS}=10\text{A}$	-	52.3	-	S
Dynamic Characteristics ^⑤						
$\mathbf{R_G}$	Gate Resistance	$V_{GS}=0\text{V}$, $V_{DS}=0\text{V}$, Freq.=1MHz	-	4.4	-	Ω
$\mathbf{C_{iss}}$	Input Capacitance	$V_{GS}=0\text{V}$, $V_{DS}=20\text{V}$, Freq.=1MHz	-	6228	-	pF
$\mathbf{C_{oss}}$	Output Capacitance		-	605	-	
$\mathbf{C_{rss}}$	Reverse Transfer Capacitance		-	453	-	
$\mathbf{t_{d(ON)}}$	Turn-on Delay Time	$V_{GS}=10\text{V}$, $V_{DS}=20\text{V}$, $I_D=1\text{A}$, $R_{GEN}=6\Omega$	-	14.2	-	nS
$\mathbf{t_r}$	Turn-on Rise Time		-	17	-	
$\mathbf{t_{d(OFF)}}$	Turn-off Delay Time		-	347.7	-	
$\mathbf{t_f}$	Turn-off Fall Time		-	110.5	-	
$\mathbf{Q_g}$	Total Gate Charge	$V_{GS}=4.5\text{V}$, $V_{DS}=20\text{V}$ $I_D=20\text{A}$	-	84.2	-	nC
$\mathbf{Q_g}$	Total Gate Charge	$V_{GS}=10\text{V}$, $V_{DS}=20\text{V}$, $I_D=20\text{A}$	-	180.6	-	
$\mathbf{Q_{gs}}$	Gate-Source Charge		-	34.1	-	
$\mathbf{Q_{gd}}$	Gate-Drain Charge		-	26.9	-	
Source-Drain Characteristics						
$\mathbf{V_{SD}}^{\circledast}$	Diode Forward Voltage	$I_{SD}=10\text{A}$, $V_{GS}=0\text{V}$	-	0.7	1.1	V
$\mathbf{t_{rr}}$	Reverse Recovery Time	$I_F=10\text{A}$, $V_R=20\text{V}$ $dI_F/dt=100\text{A}/\mu\text{s}$	-	32.7	-	nS
$\mathbf{Q_{rr}}$	Reverse Recovery Charge		-	31.9	-	nC

Note ④ : Pulse test (pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$).

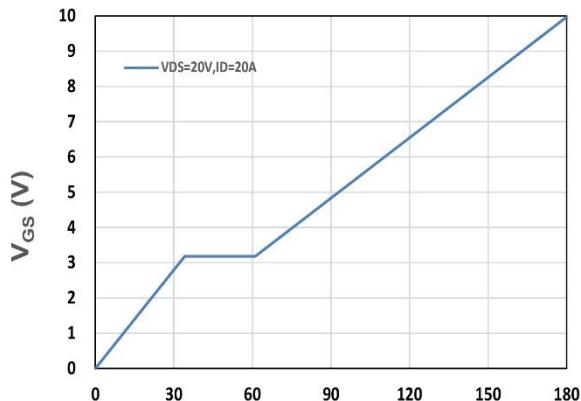
Note ⑤ : Guaranteed by design, not subject to production testing.

N-Channel Typical Characteristics

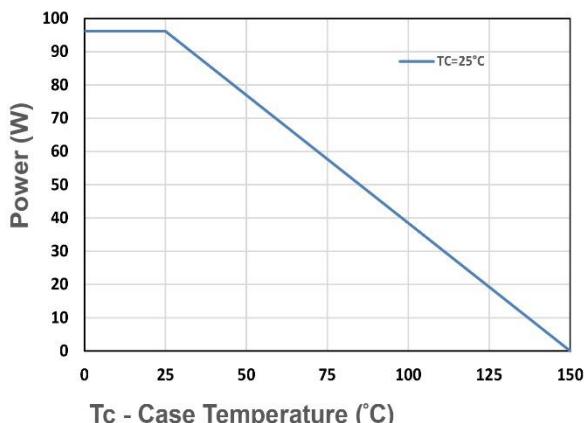




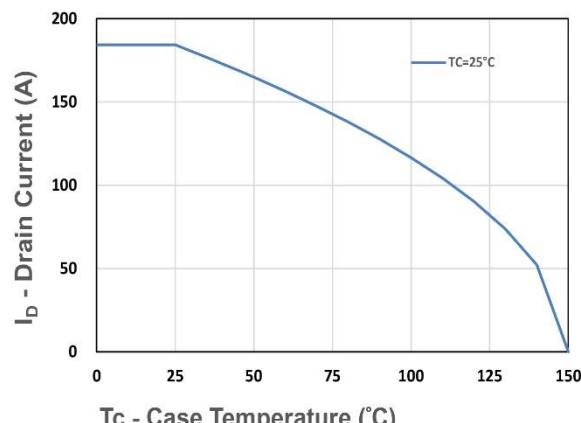
V_{DS} - Drain - Source Voltage (V)
Figure 7. Capacitance



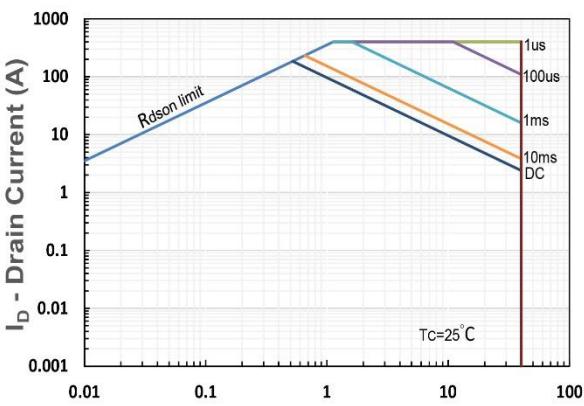
Q_g, Total Gate Charge (nC)
Figure 8. Gate Charge Characteristics



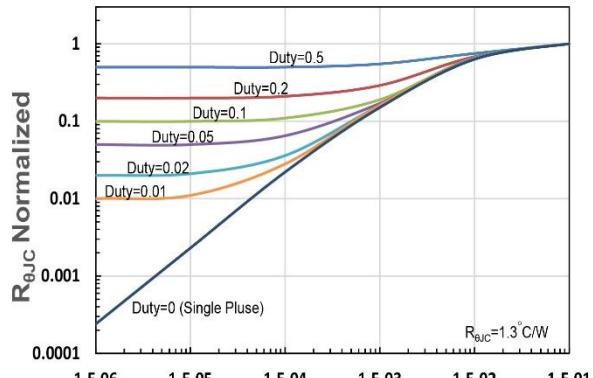
T_c - Case Temperature (°C)
Figure 9. Power Dissipation



I_D - Drain Current (A)
Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)
Figure 11. Safe Operating Area



t₁, Square Wave Pulse Duration(s)
Figure 12. R_{θJC} Transient Thermal Impedance